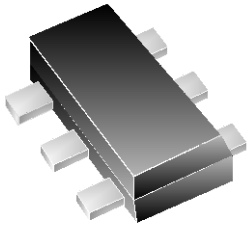
DW03MFC-B-S

Features

- Solid-state silicon-avalanche technology
- 200 Watts Peak Pulse Power per Line (t_p=8/20μs)
- Low operating and clamping voltages
- Protects five I/O lines
- Working Voltages: 3.3 V
- Low Leakage Current



SOT-563

IEC Compatibility (EN61000-4)

- IEC 61000-4-2 (ESD) ±30kV (air), ±30kV (contact)
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 15A (8/20μs)

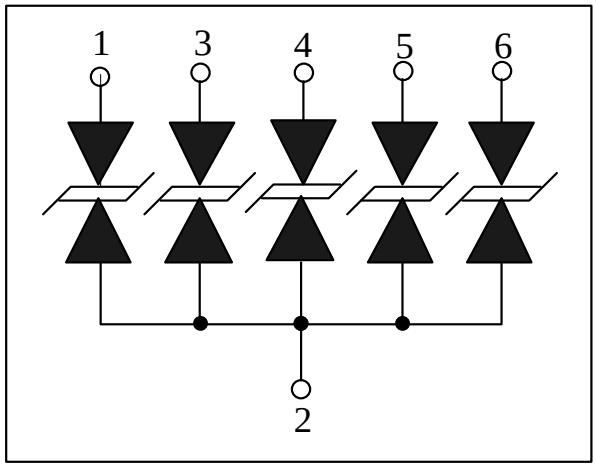
Mechanical Characteristics

- SOT-563 package
- Molding compound flammability rating: UL 94V-0
- Marking: Marking Code
- Packaging: Tape and Reel
- RoHS Compliant

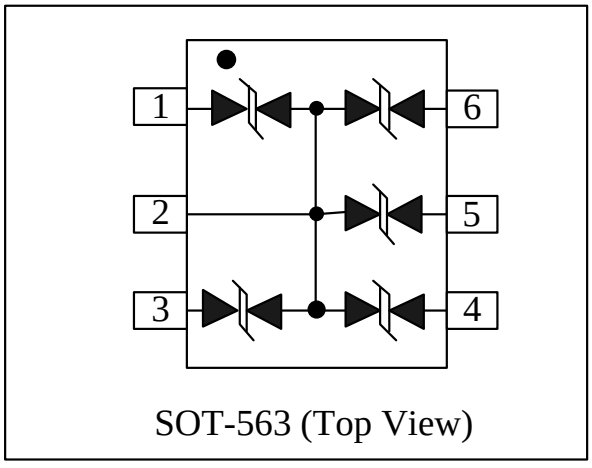
Applications

- Cellular Handsets & Accessories
- Personal Digital Assistants (PDAs)
- Notebooks & Handhelds
- Portable Instrumentation
- Digital Cameras
- MP3 Player

Circuit Diagram



Schematic & PIN Configuration

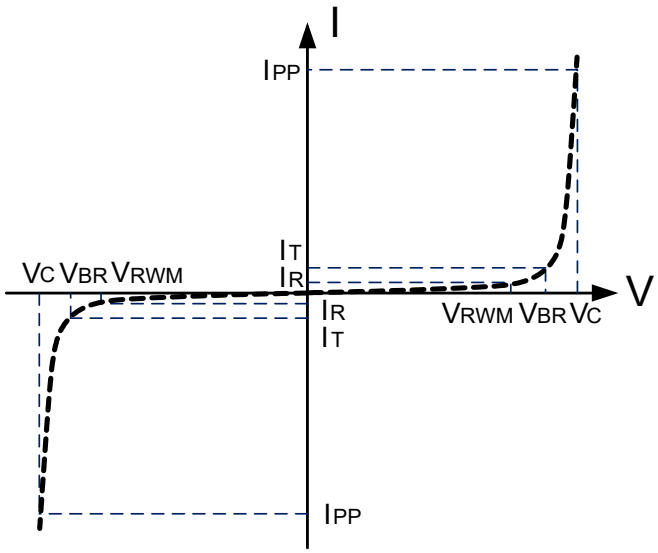


SOT-563 (Top View)

Absolute Maximum Rating			
Rating	**Symbol**	**Value**	**Units**
Peak Pulse Power (t_p =8/20μs)	P_{PP}	200	Watts
Peak Pulse Current (t_p =8/20μs)	I_{pp}	15	A
Operating Temperature	T_J	-55 to + 125	℃
Storage Temperature	T_{STG}	-55 to +150	℃

Electrical Parameters (T=25℃)

Symbol	Parameter
I_{PP}	Reverse Peak Pulse Current
V_C	Clamping Voltage @ I_{PP}
V_{RWM}	Working Peak Reverse Voltage
I_R	Reverse Leakage Current @ V_{RWM}
V_{BR}	Breakdown Voltage @ I_T
I_T	Test Current
I_F	Forward Current
V_F	Forward Voltage @ I_F



Electrical Characteristics

DW03MFC-B-S						
Parameter	**Symbol**	**Conditions**	**Minimum**	**Typical**	**Maximum**	**Units**
Reverse Stand-Off Voltage	V_{RWM}				3.3	V
Reverse Breakdown Voltage	V_{BR}	I_T=1mA	3.7			V
Reverse Leakage Current	I_R	V_{RWM}=3.3V,T=25℃			100	nA
Peak Pulse Current	I_{PP}	t_p =8/20μs			15	A
Clamping Voltage	V_C	I_{PP}=15A, t_p=8/20μs			12	V
Dynamic Resistance[1,2]	R_{DYN}	Tlp=0.2/100ns		0.202		Ω
Junction Capacitance	C_j	Between I/O pins and Ground V_R = 0V, f = 1MHz		15	18	pF

Notes
1、TLP Setting：t_p=100ns, t_r=0.2ns, I_{TLP} and V_{TLP} sample window:t_1=70ns to t_2=90ns.
2、Dynamic resistance calculated from I_{PP}=4A to I_{PP}=16A using “Best Fit”.

Typical Characteristics

Figure 1: Peak Pulse Power vs. Pulse Time

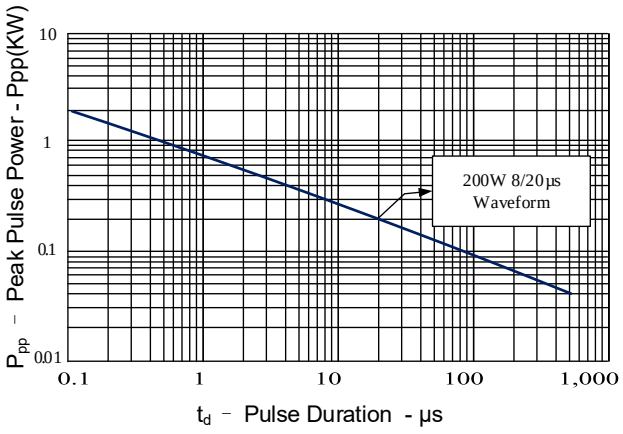


Figure 2: Power Derating Curve

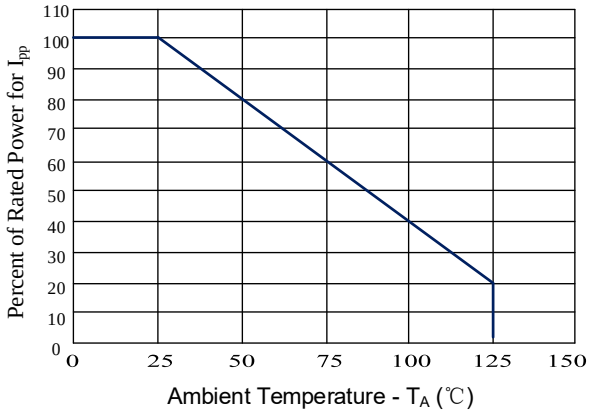


Figure 3: Clamping Voltage vs.Peak Pulse Current

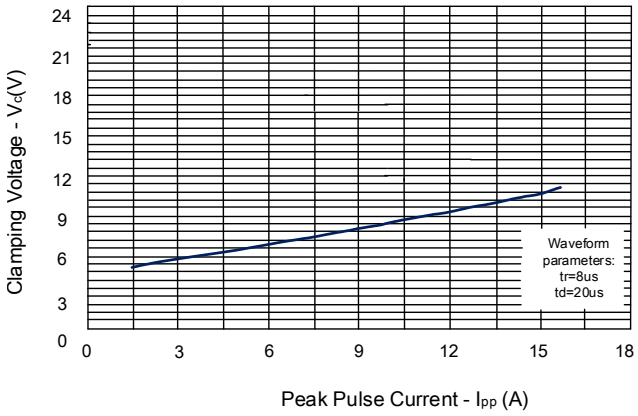


Figure 4: Normalized Junction Capacitance vs. Reverse Voltage

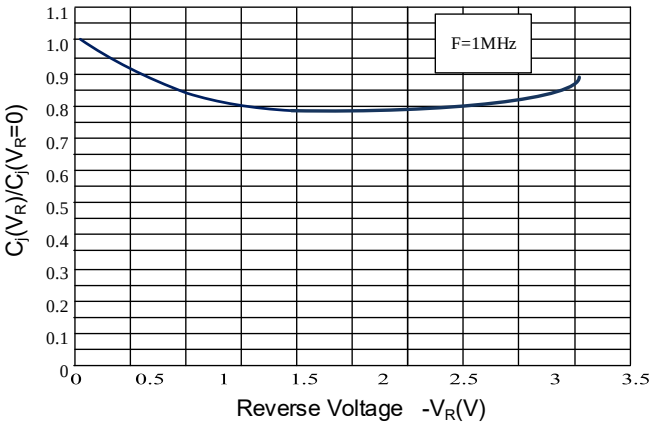


Figure 5: TLP Positive I-V Curve

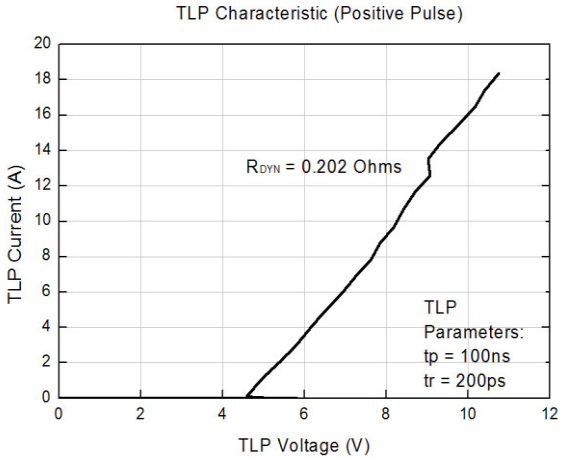
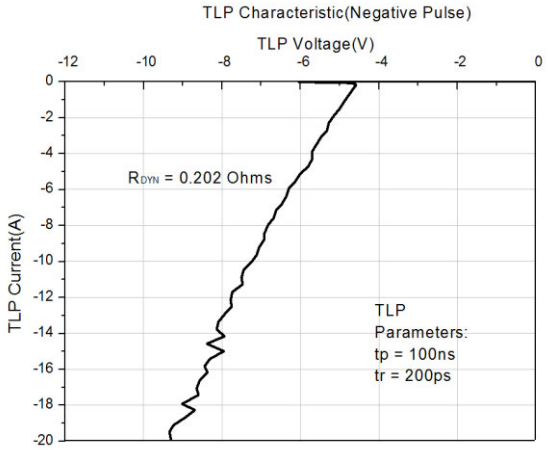


Figure 6: TLP Negative I-V Curve



Application Information

The DW03MFC-B-S was designed to protect I/O or data lines from the damaging effects of ESD or EFT. This product provides bidirectional protection; the device is connected as follows:

BIDIRECTIONAL COMMON-MODE CONFIGURATION

The DW03MFC-B-S provides up to four (4) lines of protection in a common-mode configuration as depicted in Figure 6. Circuit connectivity is as follows:

- I/O 1 is connected to Pin 3.
- I/O 2 is connected to Pin 1.
- I/O 3 is connected to Pin 6.
- I/O 4 is connected to Pin 4.
- Pin 2 is connected to ground.

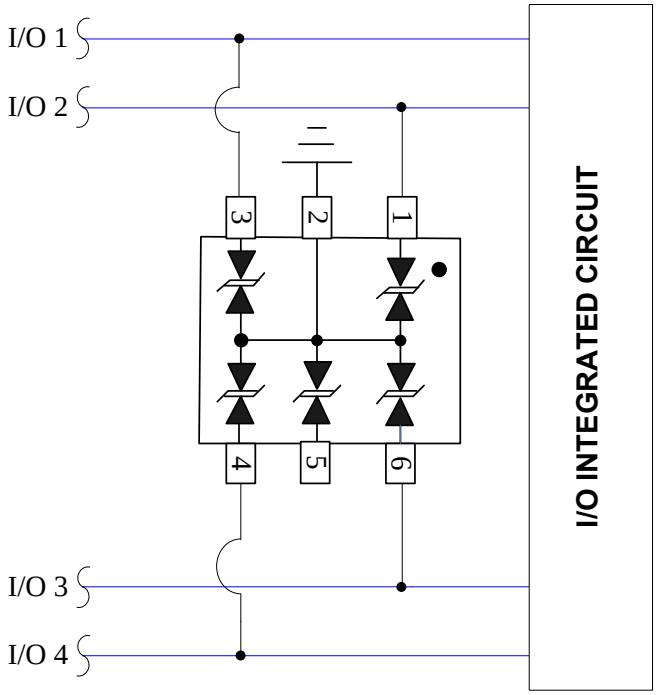


Figure 6 Bidirectional Configuration Common-Mode I/O Port Protections

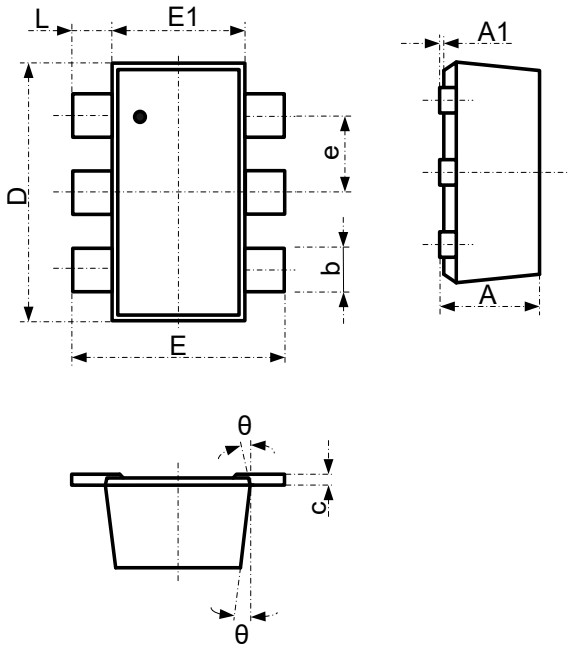
CIRCUIT BOARD LAYOUT RECOMMENDATIONS

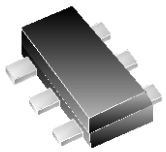
Circuit board layout is critical for Electromagnetic Compatibility (EMC) protection. The following guidelines are recommended:

- The protection device should be placed near the input terminals or connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.
- The path length between the TVS device and the protected line should be minimized.
- All conductive loops including power and ground loops should be minimized.
- The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.
- Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

Outline Drawing – SOT-563

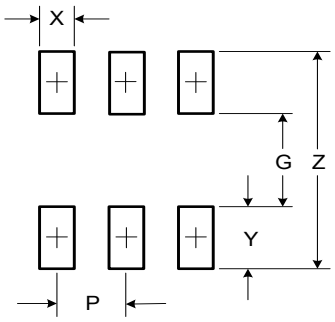
PACKAGE OUTLINE





SOT-563

DIMENSIONS				
SYMBOL	INCHES		MILLIMETER	
	MIN	MAX	MIN	MAX
A	0.021	0.024	0.525	0.600
A1	0.000	0.002	0.000	0.050
e	0.018	0.022	0.450	0.550
c	0.004	0.006	0.090	0.160
D	0.059	0.067	1.500	1.700
b	0.007	0.011	0.170	0.270
E1	0.043	0.051	1.100	1.300
E	0.059	0.067	1.500	1.700
L	0.004	0.012	0.100	0.300
θ	7°REF		7°REF	



DIMENSIONS		
DIM	INCHES	MILLIMETERS
Z	0.0752	1.91
G	0.0350	0.89
P	0.020TYP	0.51 TYP
X	0.0118	0.3
Y	0.0201	0.51

Notes

1. Dimensioning and tolerances per ANSI Y14.5M, 1985.
2. Controlling Dimension: Inches
3. Dimensions are exclusive of mold flash and metal burrs.

Marking Codes

Part Number	DW03MFC-B-S
Marking Code	B3FC

Package Information

Qty：3k/Reel